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Vishay Siliconix

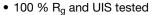
# N-Channel 250 V (D-S) MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	250				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.063				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.067				
Q <sub>g</sub> typ. (nC)	19.8				
I <sub>D</sub> (A)	24.2				
Configuration	Single				

### **FEATURES**

 ThunderFET<sup>®</sup> technology optimizes balance of R<sub>DS(on)</sub>, Q<sub>g</sub>, Q<sub>sw</sub> and Q<sub>oss</sub>

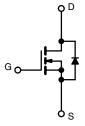


 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



### **APPLICATIONS**

- DC/DC converters
- · Primary side switching
- · Synchronous rectification
- · DC/AC and inverters



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiR692DP-T1-RE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	250	V	
Gate-source voltage		V <sub>GS</sub>	± 20	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		24.2		
	T <sub>C</sub> = 70 °C	1 . [	19.4		
	T <sub>A</sub> = 25 °C	† I <sub>D</sub>	5.9 b, c		
	T <sub>A</sub> = 70 °C	Ī	4.7 <sup>b, c</sup>		
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	50	A	
	T <sub>C</sub> = 25 °C		24.2		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	ls –	5.6 <sup>b, c</sup>		
Single pulse avalanche current	. 0.1	I <sub>AS</sub>	15		
Single pulse avalanche energy  L = 0.1 mH		E <sub>AS</sub>	11.25	mJ	
	T <sub>C</sub> = 25 °C		104		
Maximum power dissipation	T <sub>C</sub> = 70 °C	1 5	66.6	14/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	6.25 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C	†	4 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	.00	
Soldering recommendations (peak tempera	iture) <sup>c</sup>		260	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	15	20	°C/W		
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	0.9	1.2	C/VV		

### Notes

- Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- 6. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 54 °C/W.
- g.  $T_C = 25$  °C.



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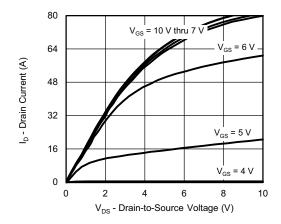
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•	
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	250	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	290	-	\//00
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-7.5	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2	-	4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	100	nA
Zana a da a di da		V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	20	-	-	Α
<b>D</b>		V <sub>GS</sub> =10 V, I <sub>D</sub> = 10 A	-	0.052	0.063	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 10 A	-	0.053	0.067	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A	-	26	-	S
Dynamic <sup>b</sup>					•	·
Input capacitance	C <sub>iss</sub>		-	1405	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 125 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	105	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	9.3	-	1
		V <sub>DS</sub> = 125 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	25.3	40	-
Total gate charge	$Q_g$	, de , b	-	19.8	30	
Gate-source charge	Q <sub>qs</sub>	V <sub>DS</sub> = 125 V, V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 10 A	_	7.9	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	7.4	-	
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 125 V, V <sub>GS</sub> = 0 V	-	49	-	
Gate resistance	$R_g$	f = 1 MHz	0.5	2	3.5	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	11	22	
Rise time	t <sub>r</sub>	$V_{DD} = 125 \text{ V}, R_L = 6.25 \Omega, I_D \cong 10 \text{ A},$	-	28	56	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	14	28	1
Fall time	t <sub>f</sub>		-	32	64	
Turn-on delay time	t <sub>d(on)</sub>		-	13	26	ns
Rise time	t <sub>r</sub>	$V_{DD} = 125 \text{ V}, R_1 = 6.25 \Omega, I_D \cong 10 \text{ A},$	_	62	124	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$	_	14	28	
Fall time	t <sub>f</sub>		-	32	60	1
Drain-Source Body Diode Characteristi	cs		l	1		
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	24.2	
Pulse diode forward current	I <sub>SM</sub>	-	-	-	50	Α
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V	-	0.77	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	146	292	ns
Body diode reverse recovery charge	Q <sub>rr</sub>		-	880	1760	nC
Reverse recovery fall time	ta	I <sub>F</sub> = 10 A, dI/dt = 100 A/μs, T <sub>J</sub> = 25 °C		98	_	
Reverse recovery rise time	t <sub>b</sub>		_	48	_	ns

### Notes

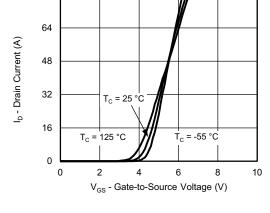
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



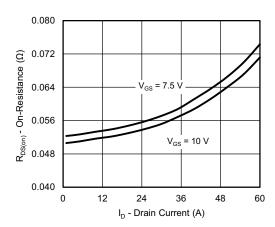


### **Output Characteristics**

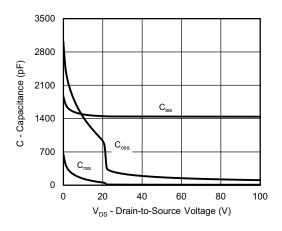


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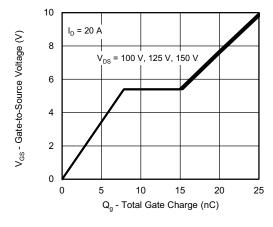
**Transfer Characteristics** 



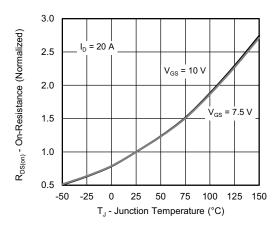
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

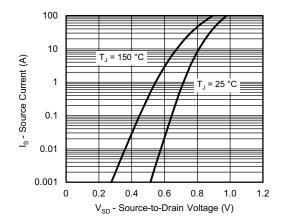


**Gate Charge** 

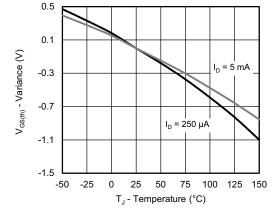


On-Resistance vs. Junction Temperature

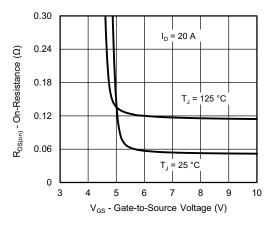




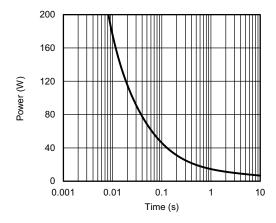
Source-Drain Diode Forward Voltage



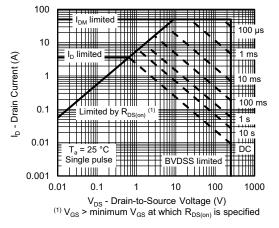
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

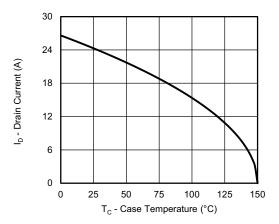


Single Pulse Power, Junction-to-Ambient

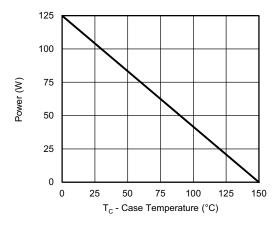


Safe Operating Area, Junction-to-Ambient

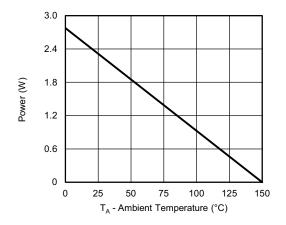




### Current Derating a





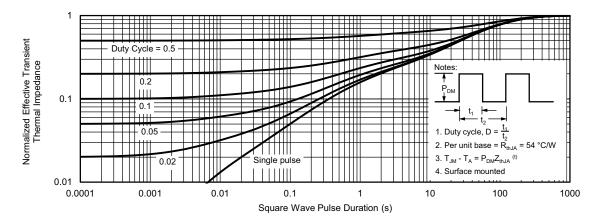


Power, Junction-to-Ambient

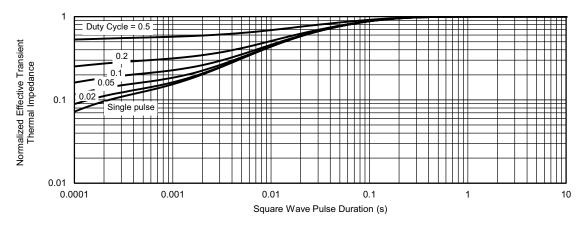
### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?75348">www.vishay.com/ppg?75348</a>.



DWG: 5881

PowerPAK® SO-8, (Single/Dual)

# Notes 1. Inch will govern. 2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

Backside View of Dual Pad

DIM.		MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX	
Α	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	_	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4		0.57 typ.		0.0225 typ.			
D5		3.98 typ.			0.157 typ.		
Е	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4		0.75 typ.			0.030 typ.		
е		1.27 BSC			0.050 BSC		
K		1.27 typ.			0.050 typ.		
K1	0.56	-	-	0.022	-	-	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М		0.125 typ.			0.005 typ.		

Revison: 13-Feb-17 1 Document Number: 71655



# RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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